COMPACT-S AI Series

Intelligent Machine Learning Unit with NVIDIA JETSON AGX Xavier NX



IPC/COMPACT A3N

This fanless COMPACT A3N generation is based on the NVIDIA Jetson AGX Xavier NX processor module and offers a wide range of interface options.

The robust and uncompromising industrial design allows the implementation in the most demanding AI applications and guarantees long term availability.

- 24/7 continuous operation
- **Extended AI Computing**
- No moving parts
- · Product lifecycle management
- Long term availability with fixed BOM



Product Highlights

Maintenance free Goldcap instead of battery backup No moving parts / passive cooling ARM CPU core Hardware watchdog Temperature supervision ESD- protection on all interfaces Long term availability (fixed BOM) Shock and vibration resistant

Product Features

384-core NVIDIA Volta™ GPU with 48 Tensor Cores 6-Core ARM v8.2 64-bit NVIDIA Carmel CPU 8GB 128-bit LPDDR4x RAM soldered on board Socket for CFast Ethernet, USB, Passive or Active CAN Optional LTE & WiFi extensions Aluminum & Stainless steel housing Protection class IP40

Markets / Applications

Industrial Automation Automated Guided Vehicle (AGV) Traffic control Transportation and vehicle construction Cleantech



Processor module / Performance			,
NVIDIA Jetson JETSON AGX XAVIER NX 384-core NVIDIA Volta™ GPU with 48 Te	nsor Cores		•
6-Core ARM v8.2 64-bit NVIDIA Carmel CPU			•
Al Performance (INT8)			21 TOPs
Memory / Storage			
Data Cache Size			2MB
128-bit LPDDR4x RAM soldered on board			8GB
eMMC 5.1 Flash Storage on board			16GB
microSD Card socket ²			1
CFast socket with retention frame ²			1
Features			
Real time clock PC compatible with battery backup Renata CR2477N (950mAh)			•
Real time clock PC compatible with Goldcap backup (48h)			optional
Hardware Watchdog & Temperature supervisor			Фиона
Intelligent power management			•
Communication Interfaces			D: 1 D +14
Graphic interface	(T A)		DisplayPort 1.4
	(Type A)		2
	(micro USB Type AB)		1
	(RJ45)		4
	(1x DSUB9)		2
	(DSUB9)		optional
Mini PCle socket ²			l
I2C bus²			•
Buzzer			•
MIPI CSI-2 / GMSL 1&2 Camera interface ¹			on request
Wireless Connectivity		(714)	
Cellular Module (LTE/UMTS/GSM) with GNSS positioning functionality Sierra Wireles	s MC7455 - M2M only!	(3x SMA)	optional
Dual SIM Support (nanoSIM to mPCle slot²)			•
Inertial measurement unit (IMU) STMicroelectronics ISM330DLC		(- 22 (111)	•
Wireless LAN IEEE 802.11a/b/g/n/ac dual-band 2x2 MIMO & Bluetooth 4.1 Sparklan	WPEB-263ACNI(BT)	(2x RP-SMA)	oprional
Technical Data			
Dimensions w174 x h52 x d127 mm (housing without mounting bracket)			•
Net weight in gram			~1000
Non isolated input voltage, with Ignition controller, reverse polarity protected			9 30VDC
Current consumption typ. in mA @ 24V without Add-Ins, idle			~400
Power consumption typ. in Watt @ 24V without Add-Ins, idle			~10
Environmental Conditions			
Operating temperature ³			−25°C +60°C
Storage temperature			−25°C +80°C
Protection standard: IP40			•
Conformal coating ⁴			tbd
Shock: EN60068-2-27 / EN61373			•
Vibration: EN60068-2-64 / EN61373			•
EMI-Conformity EN-50121-3-2			•
Safety according to EN62368-1			•
Radio and Telecommunication: Designed to meet RED			
			•
estimated MTBF ~ 150 000h (17.1 Years) @ 25°C excluding battery Please contact factory for minimum order quantities			• tbd

¹ Please contact factory for minimum order quantities

Product specifications subject to change without notice. | All data is for information purposes only and not guaranteed for legal purposes. Information in this data sheet has been carefully checked and is believed to be accurate. However, no responsibility is assumed for inaccuracies. Please refer to the user documentation for additional product specification.

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² Internal connector

³ Depending on installation situation and interface connection. Please see user documentation

⁴ On all possible components (excl. Xavier Module, connectors and wireless devices)